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Docket No. 59693 (71987)

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Y. Lee et al.

U.S. SERIAL NO.: 10/635,245

GROUP: 2811

FILED: August 5, 2003

EXAMINER: Gebremariam

FOR: GROUND-ENHANCED SEMICONDUCTOR PACKAGE AND LEAD  
FRAME FOR THE SAME

**CERTIFICATE OF FACSIMILE TRANSMISSION**

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted by facsimile to the U.S. Patent & Trademark Office by facsimile number 703-872-9306 on March 24, 2005.

By: 

Steven M. Jensen

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT**

Applicants are in receipt of the Office Action dated January 24, 2005 of the above-referenced application. Please amend the application as follows:

**Amendments to the claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 5 of this paper.